

Vishay Siliconix

N-Channel 20-V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$	I _D (A) ^a	Q _g (Typ.)			
20	$0.046 \text{ at V}_{GS} = 4.5 \text{ V}$	6	3.5 nC			
	0.063 at V _{GS} = 2.5 V	6	3.5 110			

FEATURES

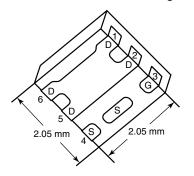
- Halogen-free According to IEC 61249-2-21
- TrenchFET[®] Power MOSFET
- New Thermally Enhanced PowerPAK[®] SC-70 Package
 - Small Footprint Area
 - Low On-Resistance
- Typical ESD Protection 1200 V

Pb-free

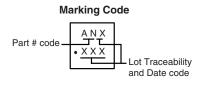
ROHS COMPLIANT HALOGEN FREE

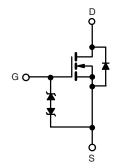
APPLICATIONS

- Load Switch for Portable Applications
- High Frequency DC/DC Converter



PowerPAK SC-70-6L-Single





Ordering Information: SiA438EDJ-T1-GE3 (Lead (Pb)-free and Halogen-free)

N-Channel MOSFET

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	20	V	
Gate-Source Voltage		V _{GS}	± 12	V	
	T _C = 25 °C		6 ^a		
Continuous Drain Current (T _{.1} = 150 °C)	T _C = 70 °C	I _D	6 ^a		
Continuous Diam Current (1) = 130 °C)	T _A = 25 °C	U'U	5.7 ^{b, c}		
	T _A = 70 °C		4.5 ^{b, c}	A	
Pulsed Drain Current		I _{DM}	15		
Continuous Source-Drain Diode Current	T _C = 25 °C		6 ^a		
Continuous Source-Drain Diode Current	T _A = 25 °C	l _s	1.75 ^{b, c}		
	T _C = 25 °C		11.4		
Maximum Power Dissipation	T _C = 70 °C	P _D	7.3	W	
Maximum Power Dissipation	T _A = 25 °C	о п	2.4 ^{b, c}	VV	
	T _A = 70 °C		1.5 ^{b, c}		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C	
Soldering Recommendations (Peak Temperature) ^{d, e}			260		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{b, f}	t ≤ 5 s	R _{thJA}	41	52	°C/W	
Maximum Junction-to-Case (Drain)	Steady State	$R_{th,IC}$	9	11	0/11	

Notes:

- a. Package limited
- b. Surface Mounted on 1" x 1" FR4 board.
- c. t = 5 s.
- d. See Solder Profile (<u>www.vishay.com/ppg?73257</u>). The PowerPAK SC-70 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- e. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.
- f. Maximum under Steady State conditions is 90 °C/W.

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SPECIFICATIONS $T_J = 25 ^{\circ}C$,	unless other	wise noted					
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	20			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	J 050A		23		\//°C	
GS(th) Temperature Coefficient ΔV _{GS(th)}		$I_D = 250 \mu\text{A}$		- 3.3		mV/°C	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	0.6		1.4	V	
Oata Carrea Lagliana	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$			± 70		
Gate-Source Leakage		$V_{DS} = 0 \text{ V}, V_{GS} = \pm 4.5 \text{ V}$			± 1		
		V _{DS} = 20 V, V _{GS} = 0 V			- 1	μΑ	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 20 V, V _{GS} = 0 V, T _J = 55 °C			- 10	1	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	10			Α	
	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 3.9 \text{ A}$		0.037	0.046	Ω	
Drain-Source On-State Resistance ^a		V _{GS} = 2.5 V, I _D = 3.3 A		0.051	0.063		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 10 V, I _D = 3.9 A		14		S	
Dynamic ^b		1	1				
Input Capacitance	C _{iss}			350		pF	
Output Capacitance	C _{oss}	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		63			
Reverse Transfer Capacitance	C _{rss}			37			
<u>'</u>		V _{DS} = 10 V, V _{GS} = 10 V, I _D = 5.1 A		7.5		nC	
Total Gate Charge	Q_g			3.5	5.5		
Gate-Source Charge	Q _{gs}	$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 5.1 \text{ A}$		0.95			
Gate-Drain Charge	Q _{gd}			0.75			
Gate Resistance	R _g	f = 1 MHz		3.5		Ω	
Turn-On Delay Time	t _{d(on)}			10	15		
Rise Time	t _r	1		12	20		
Turn-Off Delay Time	t _{d(off)}	$V_{DD} = 10 \text{ V}, R_L = 2.4 \Omega$ $I_D \cong 4.1 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		18	30		
Fall Time	t _f	$ID = 4.1 \text{ A}, V_{GEN} = 4.3 \text{ V}, H_g = 1.22$		12	20		
Turn-On Delay Time	t _{d(on)}			5	10	ns	
Rise Time	t _r			12	20		
Turn-Off Delay Time	t _{d(off)}	V_{DD} = 10 V, R_L = 2.4 Ω $I_D \cong 4.1$ A, V_{GEN} = 10 V, R_q = 1 Ω		15	25		
Fall Time	t _f	$I_D = 4.1 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 152$		10	15		
Drain-Source Body Diode Characteristic	:s		l				
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			6		
Pulse Diode Forward Current	I _{SM}				15	Α	
Body Diode Voltage	V _{SD}	I _S = 4.1 A, V _{GS} = 0 V	İ	0.8	1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			15	30	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	1 44 4 41/41 400 4/ 7 67 00		8	20	nC	
Reverse Recovery Fall Time	t _a	$I_F = 4.1 \text{ A, dI/dt} = 100 \text{ A/}\mu\text{s, T}_J = 25 \text{ °C}$		8			
Reverse Recovery Rise Time	t _b			7		ns	
<u> </u>	_ ~	<u> </u>	1	ı	1	1	

Notes:

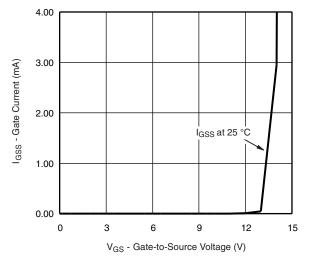
- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

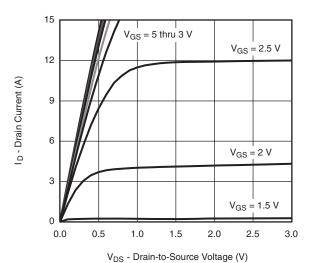


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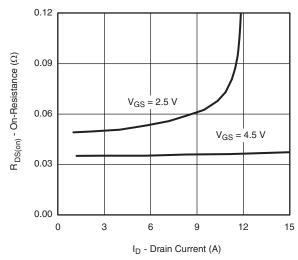
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



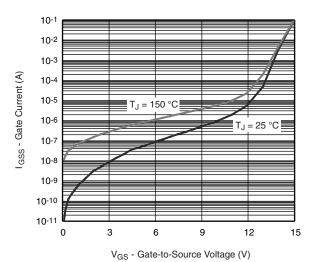
Gate Current vs. Gate-Source Voltage



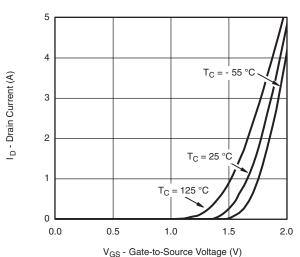
Output Characteristics



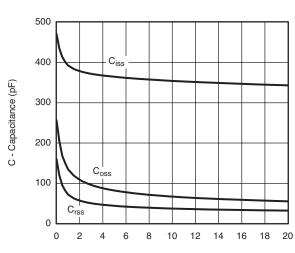
On-Resistance vs. Drain Current and Gate Voltage



Gate Current vs. Gate-Source Voltage



Transfer Characteristics



V_{DS} - Drain-to-Source Voltage (V)

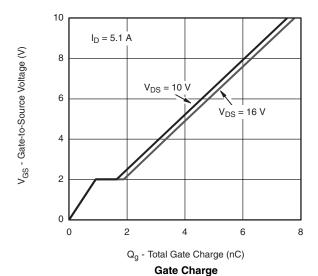
Capacitance

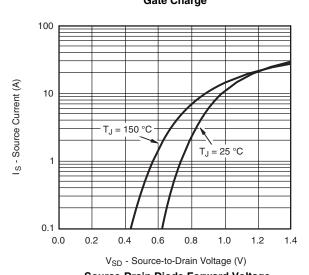
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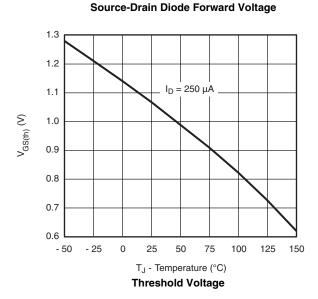
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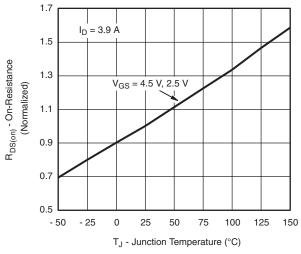
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

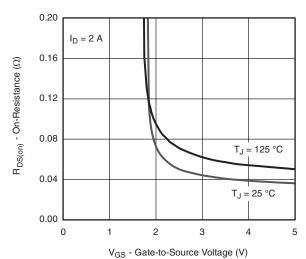




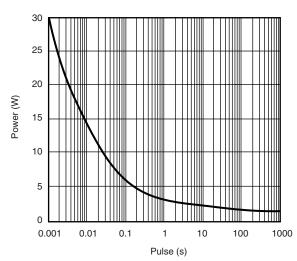




On-Resistance vs. Junction Temperature



On-Resistance vs. Gate-to-Source Voltage

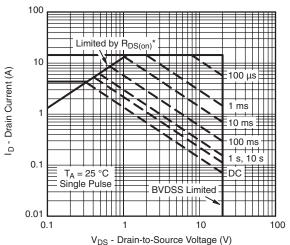


Single Pulse Power (Junction-to-Ambient)



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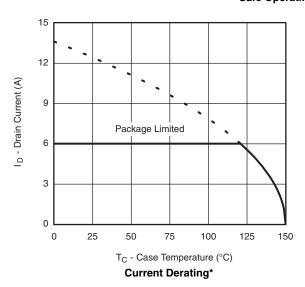
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

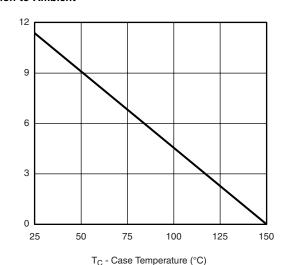


* V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

Safe Operating Area, Junction-to-Ambient

Power Dissipation (W)





Power Derating

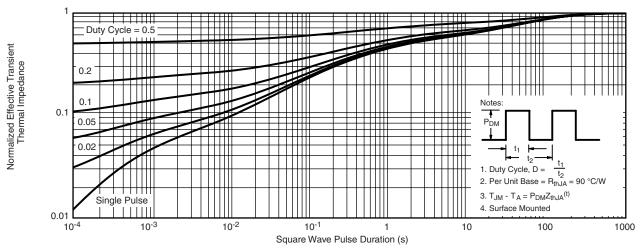
^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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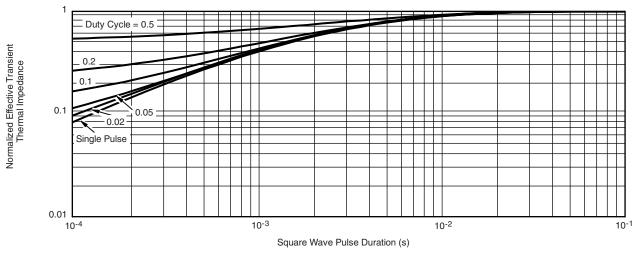
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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